

Features

- Lead free
- RoHS compliant*
- Multiple resistors tied to a common node
- Stable thin-film-on-silicon technology
- Ultra-miniature packages to JEDEC standards



Applications

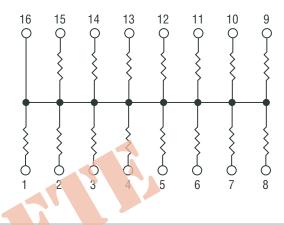
- Bus termination
- Pull-up/pull-down
- Ideal for space-constrained applications

Thin Film on Silicon 2QSP / 2NBS-XX2 Bussed Resistors

General Information

Bussed Resistor networks are typically used in DC pull-up and pull-down applications where system data or control lines must be tied to a fixed potential. Fabricated with a Tantalum Nitride and Nickel Chromium on Silicon process, these resistors feature excellent stability, TCR and tracking performance. Bussed Resistor Networks are available in a range of miniature package types conforming to JEDEC standards.

Package Schematic



Electrical & Environmental Characteristics

Electrical Characteristics	Symbol	Minimum	Nominal	Maximum	Unit
Resistance Range	R	100		100 K	Ω
Tolerance:					
Absolute		±0.5 %		±5 %	Ω
Ratio		±0.1 %		±2 %	Ω
TCR:					
Absolute			100	150	ppm/°C
Tracking				25	ppm/°C
Operating Voltage				50	V
Environmental Characteristics					
ESD		2 K			V
Operating Temperature	Тј	-55		+125	°C
Storage Temperature	T _{stg}	-65		+150	°C
Power Rating per Resistor @ 70 °C				0.1	Watt
Power Rating per Package @ 70 °C:					
QSOP: 16 Pin				0.75	Watt
20, 24 Pin				1.00	Watt
28 Pin				1.12	Watt
NBSOIC: 8 Pin				0.60	Watt
14, 16 Pin				1.00	Watt

Specifications are subject to change without notice.

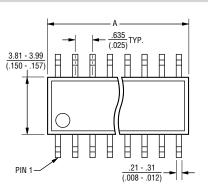
Customers should verify actual device performance in their specific applications.

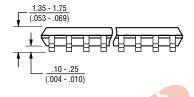
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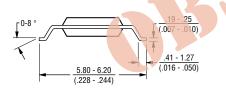
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Mechanical Characteristics

QSOP Package Dimensions





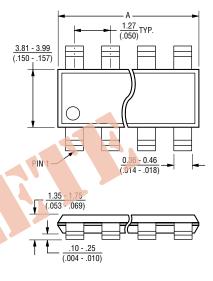


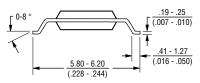
Model	A			
2QSP16	4.80 - 4.98 (.189196)			
2QSP20	8.56 - 8.74 (.337344)			
2QSP24	8.56 - 8.74 (.337344)			
2QSP28	9.80 - 9.98 (.386393)			

Governing dimensions are in mm. Dimensions in parentheses are in inches and are approximate.

JEDEC Reference Number MO-137.







Model	A			
2NBS08	4.80 - 4.98 (.189196)			
2NBS14	8.56 - 8.74 (.337344)			
2NBS16	9.80 - 9.98 (.386393)			

Governing dimensions are in mm. Dimensions in parentheses are in inches and are approximate.

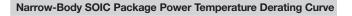
JEDEC Reference Number MS-012.

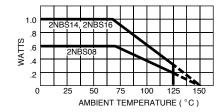
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150

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QSOP Package Power Temperature Derating Curve







1.25

1.0

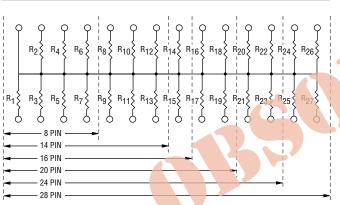
.25

0

2QSP16

25 50 75 100 125

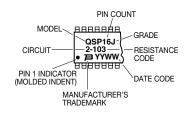
.75 STIN .50



AMBIENT TEMPERATURE (°C)

Typical Part Marking

Represents total content. Layout may vary.



Standard Resistance Values

	Resistance	Resistance
	(ohms)	Code
X	100	101 121
	220	221
	270 330 390	271 331 391
	470 510 680	471 511 681
	1 K 1.5 K 2 K	102 152 202
	2.2 K 2.7 K 3.3 K	222 272 332
	4.7 K 5.1 K 10 K	472 512 103
	20 K 27 K 47 K	203 273 473
	51 K 75 K 82 K 100 K	513 753 823 104

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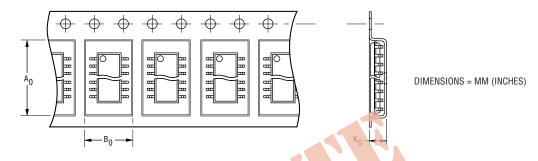
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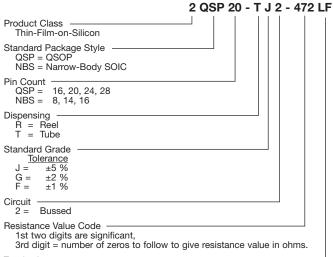
Dispensing

For large quantities, the product will be dispensed in Tape and Reel (see diagram below).



Package	A ₀	B ₀	K ₀	Width	Pitch	No. of Pieces per 13 reel	No. of Pieces per tube
QSOP							
16 Pin	6.4 (0.252)	5.2 (0.205)	2.1 (0.083)	12 (0.472)	8 (0.315)	3,500	98
20, 24 Pin	6.5 (0.256)	9.0 (0.354)	2.1 (0.083)	16 (0.630)	8 (0.315)	3,500	56
28 Pin	6.5 (0.256)	10.3 (0.406)	2.1 (0.083)	16 (0.630)	8 (0.315)	3,500	49
NBSOIC							
8 Pin	6.4 (0.252)	9.0 (0.354)	2.1 (0.083)	12 (0.472)	8 (0.315)	3,500	98
14 Pin	6.5 (0.256)	9.0 (0.354)	2.1 (0.083)	16 (0.630)	8 (0.315)	3,500	56
16 Pin	6.5 (0.256)	9.0 (0.354)	2.1 (0.083)	16 (0.630)	8 (0.315)	3,500	49





Terminations LF = 100 % Sn (lead free)



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